

ABSTRACT

5 A photosensitive resin composition according to the present disclosure contains a maleimide compound, a crosslinking agent, and a photopolymerization initiator, the maleimide compound is a reaction product of a tetracarboxylic acid dianhydride (a1), an amine (a2), and maleic anhydride (a3), the amine (a2) includes a dimer diamine and a second amine other than a dimer diamine, and at least one of the tetracarboxylic acid dianhydride (a1) and the amine (a2) includes a compound having a biphenyl skeleton.